

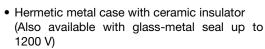
# Phase Control Thyristors (Stud Version), 230 A



PRODUCT SUMMARY			
I <sub>T(AV)</sub>	230 A		
V <sub>DRM</sub> /V <sub>RRM</sub>	400 V, 1600 V		
$V_{TM}$	1.55 V		
l <sub>GT</sub>	150 mA		
$T_J$	-40 °C to 125 °C		
Package	TO-209AB (TO-93)		
Diode variation	Single SCR		

#### **FEATURES**

- Center amplifying gate
- International standard case TO-209AB (TO-93)





- Compression bonded encapsulation for heavy duty operations such as severe thermal cycling
- · Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **TYPICAL APPLICATIONS**

- DC motor controls
- · Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS					
PARAMETER	TEST CONDITIONS	VALUES	UNITS		
1		230	A		
I <sub>T(AV)</sub>	T <sub>C</sub>	85	°C		
I <sub>T(RMS)</sub>		360	A		
	50 Hz	5700	- A		
I <sub>TSM</sub>	60 Hz	5970	^		
I <sup>2</sup> t	50 Hz	163	kA <sup>2</sup> s		
1-1	60 Hz	149	KA-S		
$V_{DRM}/V_{RRM}$		400 to 1600	V		
t <sub>q</sub>	Typical	100	μs		
T <sub>J</sub>		-40 to 125	°C		

#### **ELECTRICAL SPECIFICATIONS**

VOLTAGE RATINGS							
TYPE NUMBER	VOLTAGE CODE	V <sub>DRM</sub> /V <sub>RRM</sub> , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	$\begin{split} I_{DRM}/I_{RRM} & \text{MAXIMUM AT} \\ T_J = T_J & \text{MAXIMUM} \\ & \text{mA} \end{split}$			
	04	400	500				
VC CTOOC	08	800	900	30			
VS-ST230S 12		1200	1300	30			
	16	1600	1700				



ABSOLUTE MAXIMUM RATINGS	3					
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS
Maximum average on-state current	I <sub>T(AV)</sub>	180° conduction, half sine wave		230	A °C	
at case temperature		50 . 50 . 6			85	30
Maximum RMS on-state current	I <sub>T(RMS)</sub>	DC at 78 °C	case temperati	ure	360	
		t = 10 ms	No voltage		5700	
Maximum peak, one-cycle		t = 8.3 ms	reapplied		5970	A - kA <sup>2</sup> s
non-repetitive surge current	I <sub>TSM</sub>	t = 10 ms	100 % V <sub>RRM</sub>		4800	
		t = 8.3 ms	reapplied	Sinusoidal half wave, initial $T_J = T_J$ maximum	5000	
Maximum I <sup>2</sup> t for fusing	l <sup>2</sup> t	t = 10 ms	No voltage		163	
		t = 8.3 ms	reapplied		148	
Maximum i-t for fusing		t = 10 ms	100 % V <sub>RRM</sub>		115	
		t = 8.3 ms	reapplied		105	
Maximum I <sup>2</sup> √t for fusing	l²√t	t = 0.1 to 10	t = 0.1 to 10 ms, no voltage reapplied		1630	kA²√s
Low level value of threshold voltage	V <sub>T(TO)1</sub>	(16.7 % x π	(16.7 % x $\pi$ x $I_{T(AV)} < I < \pi$ x $I_{T(AV)}$ ), $T_J = T_J$ maximum		0.92	V
High level value of threshold voltage	V <sub>T(TO)2</sub>	$(I > \pi \times I_{T(AV)})$	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			]
Low level value of on-state slope resistance	r <sub>t1</sub>	(16.7 % x $\pi$ x $I_{T(AV)}$ < I < $\pi$ x $I_{T(AV)}$ ), $T_J = T_J$ maximum		0.88	mΩ	
High level value of on-state slope resistance	r <sub>t2</sub>	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			0.81	11152
Maximum on-state voltage	$V_{TM}$	$I_{pk} = 720 \text{ A}, T_J = T_J \text{ maximum}, t_p = 10 \text{ ms sine pulse}$		1.55	V	
Maximum holding current	Ι <sub>Η</sub>	T. – 25 °C	anode supply 1	2 V resistive load	600	mA
Maximum (typical) latching current	ΙL	T <sub>J</sub> = 25 °C, anode supply 12 V resistive load		1000 (300)	111/4	

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 $\Omega$ , $t_r \le 1~\mu s$ $T_J = T_J$ maximum, anode voltage $\le 80~\%~V_{DRM}$	1000	A/µs
Typical delay time	t <sub>d</sub>	Gate current 1 A, $dl_g/dt = 1 A/\mu s$ $V_d = 0.67 \% V_{DRM}, T_J = 25 °C$	1.0	
Typical turn-off time	t <sub>q</sub>	$I_{TM} = 300 \text{ A, } T_J = T_J \text{ maximum, } dI_F/dt = 20 \text{ A/}\mu\text{s,}$ $V_R = 50 \text{ V, } dV/dt = 20 \text{ V/}\mu\text{s, } \text{gate } 0 \text{ V } 100 \Omega, t_p = 500 \mu\text{s}$	100	μs

BLOCKING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum critical rate of rise of off-state voltage	dV/dt	T <sub>J</sub> = T <sub>J</sub> maximum linear to 80 % rated V <sub>DRM</sub>	500	V/µs
Maximum peak reverse and off-state leakage current	I <sub>RRM</sub> , I <sub>DRM</sub>	$T_J = T_J$ maximum, rated $V_{DRM}/V_{RRM}$ applied	30	mA



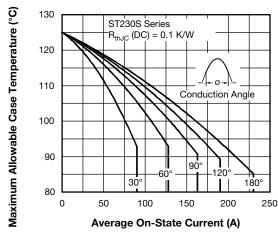
TRIGGERING						
PARAMETER	SYMBOL	-	TECT COMPLETIONS		VALUES	
PARAMETER	STWIDGE	•	EST CONDITIONS	TYP.	MAX.	UNITS
Maximum peak gate power	P <sub>GM</sub>	$T_J = T_J$ maximum,	t <sub>p</sub> ≤ 5 ms	10.0		W
Maximum average gate power	P <sub>G(AV)</sub>	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	VV
Maximum peak positive gate current	I <sub>GM</sub>	$T_J = T_J$ maximum,	t <sub>p</sub> ≤ 5 ms	3.	.0	Α
Maximum peak positive gate voltage	+ V <sub>GM</sub>	T T manyimay ma	+ < F ma	20		V
Maximum peak negative gate voltage	- V <sub>GM</sub>	$T_J = T_J$ maximum, $t_p \le 5$ ms		5.0		\ \ \
		T <sub>J</sub> = - 40 °C		180	-	
DC gate current required to trigger	$I_{GT}$	T <sub>J</sub> = 25 °C	90	150	mA	
		T <sub>J</sub> = 125 °C	Maximum required gate trigger/ current/voltage are the lowest value which will trigger all units 12 V anode to cathode applied	40	-	
		T <sub>J</sub> = - 40 °C		2.9	-	
DC gate voltage required to trigger	$V_{GT}$	T <sub>J</sub> = 25 °C		1.8	3.0	V
		T <sub>J</sub> = 125 °C		1.2	-	
DC gate current not to trigger	I <sub>GD</sub>	T. T. massimum	Maximum gate current/voltage not to trigger is the maximum value	10		mA
DC gate voltage not to trigger	$V_{GD}$	$T_J = T_J \text{ maximum}$	which will not trigger any unit with rated V <sub>DRM</sub> anode to cathode applied	0.25		V

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum operating junction temperature range	TJ		-40 to 125	°C	
Maximum storage temperature range	T <sub>Stg</sub>		-40 to 150		
Maximum thermal resistance, junction to case	R <sub>thJC</sub>	DC operation	0.10	KVV	
Maximum thermal resistance, case to heatsink	R <sub>thC-hs</sub>	Mounting surface, smooth, flat and greased	0.04	- K/W	
Mounting torque + 10 %		Non-lubricated threads	31 (275)	N⋅m	
Mounting torque, ± 10 %		Lubricated threads	24.5 (210)	(lbf · in)	
Approximate weight			280	g	
Case style		See dimensions - link at the end of datasheet	TO-209AB (	TO-93)	

△R <sub>thJC</sub> CONDUCTION					
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDITIONS	UNITS	
180°	0.016	0.012			
120°	0.019	0.020			
90°	0.025	0.027	$T_J = T_J$ maximum	K/W	
60°	0.036	0.037			
30°	0.060	0.060			

#### Note

The table above shows the increment of thermal resistance R<sub>thJC</sub> when devices operate at different conduction angles than DC





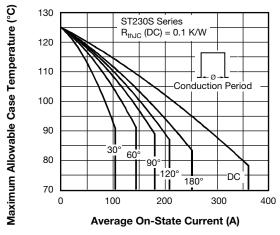


Fig. 2 - Current Ratings Characteristics

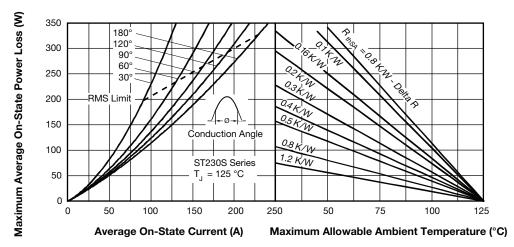


Fig. 3 - On-State Power Loss Characteristics

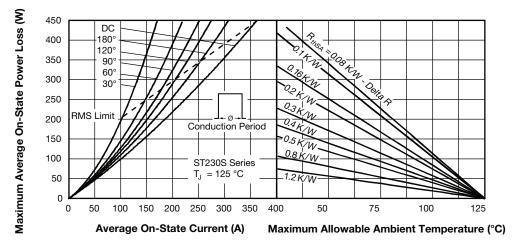


Fig. 4 - On-State Power Loss Characteristics

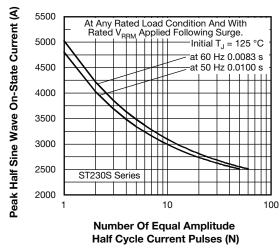


Fig. 5 - Maximum Non-Repetitive Surge Current

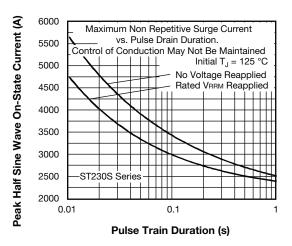


Fig. 6 - Maximum Non-Repetitive Surge Current

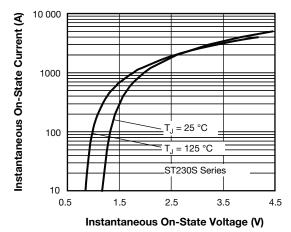


Fig. 7 - On-State Voltage Drop Characteristics

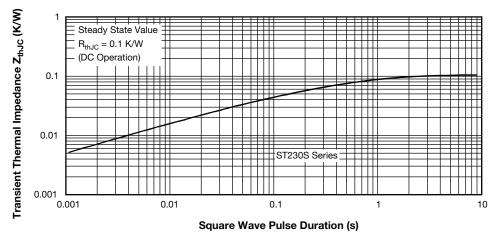


Fig. 8 - Thermal Impedance Z<sub>thJC</sub> Characteristics

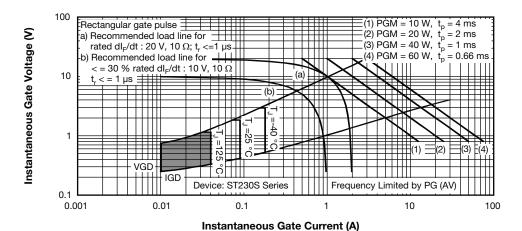
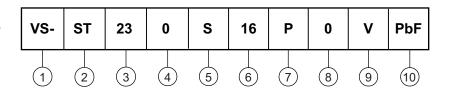


Fig. 9 - Gate Characteristics

#### **ORDERING INFORMATION TABLE**

**Device code** 



Vishay Semiconductors product

2 **Thyristor** 

3 Essential part number

0 = Converter grade

S = Compression bonding stud

Voltage code x 100 = V<sub>RRM</sub> (see Voltage Ratings table) 6

P = Stud base 3/4"-16UNF2A threads

0 = Eyelet terminals (gate and auxiliary cathode leads)

1 = Fast-on terminals (gate and auxiliary cathode leads)

9 • V = Glass-metal seal (only up to 1200 V)

• None = Ceramic housing (over 1200 V)

10 None = Standard production

PbF = Lead (Pb)-free

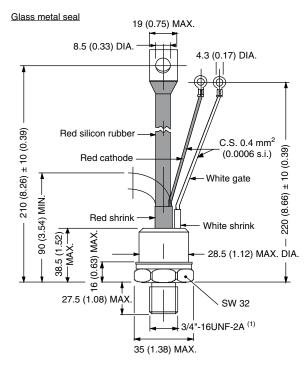
Note: For metric device M16 x 1.5 contact factory

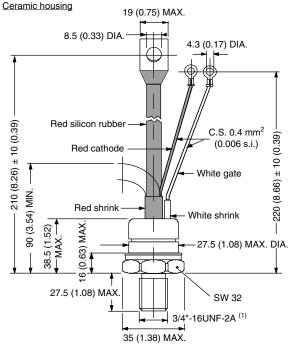
LINKS TO RELAT	
Dimensions	www.vishay.com/doc?95082

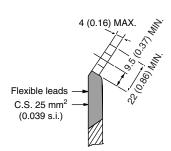


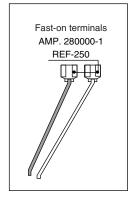
# TO-209AB (TO-93)

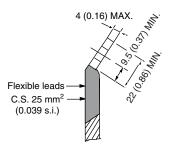
#### **DIMENSIONS** in millimeters (inches)











#### Note

(1) For metric device: M16 x 1.5 - length 21 (0.83) maximum



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Vishay

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